

Ferrite Chip Bead(Lead Free)

FCM1005KF-601T01

ECN HISTORY LIST

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	13/06/06	變更可靠度條件	楊祥忠	羅培君	張嘉玲
2.0	14/01/24	變更電鍍錫層厚度 3.0um min.=>3.5um min.	楊祥忠	羅培君	張嘉玲
3.0	14/03/20	修正包裝帶圖示	楊祥忠	羅培君	張嘉玲
4.0	14/08/01	變更 Reflow 圖示	楊祥忠	羅培君	張嘉玲
4.1	14/08/01	修正包裝帶尺寸	楊祥忠	羅培君	張嘉玲
5.0	16/01/26	增訂可靠度 Thermal shock: (Bead) Step3 : 125±2°C 30±5min	楊祥忠	詹偉特	張嘉玲
6.0	17/02/16	修訂 Recommended PC Board Pattern	楊祥忠	詹偉特	張嘉玲
備註					

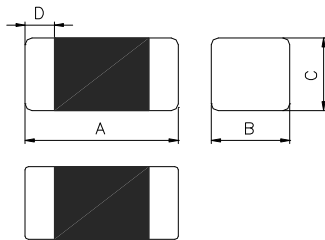
Ferrite Chip Bead(Lead Free) FCM1005KF-601T01

1.Features

1. Monolithic inorganic material construction.
2. Closed magnetic circuit avoids crosstalk.
3. S.M.T. type.
4. Suitable for reflow soldering.
5. Shapes and dimensions follow E.I.A. spec.
6. Available in various sizes.
7. Excellent solder ability and heat resistance.
8. High reliability.
9. 100% Lead(Pb) & Halogen-Free and RoHS compliant.



2.Dimensions



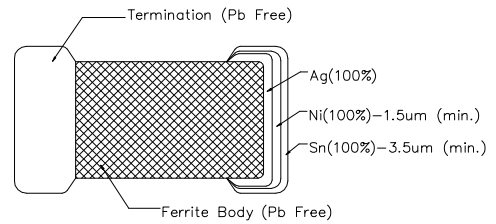
Chip Size	
A	1.00±0.10
B	0.50±0.10
C	0.50±0.10
D	0.25±0.10

Units: mm

3.Part Numbering



- A: Series
- B: Dimension L x W
- C: Material Lead Free Material
- D: Impedance 601=600Ω
- E: Packaging T=Taping and Reel, B=Bulk(Bags)
- F: Rated Current 01=100mA



4.Specification

Tai-Tech Part Number	Impedance (Ω)	Test Frequency (Hz)	DC Resistance (Ω) max.	Rated Current (mA) max.
FCM1005KF-601T01	600±25%	60mV/100M	0.80	100

- Rated current: based on temperature rise test
- In compliance with EIA 595

■ Impedance-Frequency Characteristics

